08-23-2007

U.S. PTO 11/893226 08/14/2007

<i>h)</i> -	103439091 <u>fates pat</u>	ENT AND TRADE Type of Deposit August 14, 2007
	In re application of: Takatsugu OMATA et al. Serial No: Filed: Herewith For: Method For Manufacturing Semiconductor Device Art Unit: Examiner:  PATENT ASSIGNMENT	)  I hereby certify that this correspondence is being deposited with the United States Postal Service  Express Mail Post Office to Addressee' service under 37 CFR1.10 on the date indicated above and is addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450  MENT COVER SHEET
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	Alexandria, VA 22313-1450	Signature and Jenne
	Sir:  Please record the attached original document or copy th	ereof. Total number of pages (with cover sheet): 2
	Name of Conveying Party(ies):     Takatsugu OMATA and Koichiro TANAKA	5. Name and Address of Party to Whom Correspondence Concerning Document Should be Mailed:
	2a. Name and Address of Receiving Party(ies): Name: Semiconductor Energy Laboratory Co., Ltd. Address: 398, Hase, Atsugi-shi, Kanagawa-ken 243-0036 Japan	Edward D. Manzo, Esq.  COOK, ALEX, McFARRON, MANZO, CUMMINGS &  MEHLER, LTD.  200 West Adams Street, Suite 2850
	2b. Name and Address of Receiving Party(ies): Name: Address	Chicago, Illinois 60606  6. Total Number of Applications and Patents Involved: _1
	3. Nature of Conveyance  X Assignment  Merger  Security Agreement  Change of Name  11/893 2-2 6	7. Total Fee (37 CFR 3.41): \$40.00 7a. X Enclosed 7b. X Authorized to be Charged to Deposit Account For Any Deficiency
	_OtherX Execution Date: 7/26/07	8. Deposit Account Number: 50/1039 (A duplicate copy of this page is attached)
	4. Application Number(s) or Patent number(s) (If this document is being filed together with a new application, the execution date of the application is: 7/26/07	9. Statement and Signature: To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.
	4a. Patent Application No.(s)  4b. Patent No.(s)  /2007 WARDELR1 00000006 11893226	Mark J. Murphy Name of Person Signing Signature Reg. No. 34,225
16 F	(18021 (40.00 BP )	Date: August 4, 2007
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PATENT REEL: 019751 FRAME: 0862

ASSIGNMENT		
Identity Of The Patent Application. I am the inventor (or one joint inventor) of a patent application that I am assigning. The patent application I am assigning is entitled <a href="METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICE">METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICE</a> which I executed herewith. If the patent application has already been filed, it received serial number and bears a filing date of		
The Assignee and The Assignment. I assign my patent rights to Semiconductor Energy Laboratory Co., Ltd. a corporation organized according to the laws of Japan, having a place of business at 398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan (hereinafter "the Assignee"). The rights I assign are my entire right, title and interest in the invention or improvements disclosed in the patent application and any and all other applications for United States Letters Patent which I may file, either solely or jointly with others, on the invention or improvements, including all continuations, divisionals, and continuations-in-part, and in any and all United States Letters Patent which may be obtained on any of said applications, and in any reissue or extension thereof. I also assign to the Assignee all priority rights under the International Convention. I agree to execute, at the request of the Assignee, all documents in connection with any application for United States letters patent therefor.		
Payment Received. I am making this assignment in consideration of One Dollar and other good and valuable consideration. I acknowledge the receipt and sufficiency of the consideration.		
Authorizations. I request the U.S. Commissioner of Patents and Trademarks to issue the Letters Patent to the Assignee. I authorize the attorney(s) of record in the application to insert in this assignment document the date and serial number of the application.		
Further Acts. I agree, upon the request and at the expense of the Assignee, to execute any divisional, continuation or substitute application for the invention or improvements, and any oath, declaration or affidavit relating thereto, and any application for the reissue or extension of any Letters Patent that may be granted upon the application. I agree to perform, upon request, any affirmative acts to obtain said Letters Patent of the United States and to vest in the Assignee all rights therein, so that the Letters Patent will be held and enjoyed by the Assignee, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me if this assignment had not been made.		
In the event that any application or Letters Patent that I now assign becomes involved in interference, I agree to cooperate to the best of my ability in the matters of preparing and executing the preliminary statement and giving and producing evidence in support thereof.		
Lahatange Practa 07/26/2007  Name: Takatsugu OMATA  Date		
Name: Takatsugu OMATA Date		

PATENT REEL: 019751 FRAME: 0863

Attorney Docket \_\_\_\_

**RECORDED: 08/14/2007** 

Name: Koichiro TANAKA 07/26/2007